

RoHS

COMPLIANT

HALOGEN

**Vishay Siliconix** 

## Dual N-Channel 40 V (D-S) MOSFET

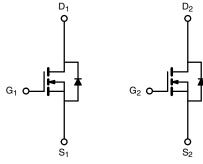
PRODUCT SUMMARY					
V <sub>DS</sub> (V)	<b>R<sub>DS(on)</sub> (</b> Ω <b>)</b>	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)		
40	0.020 at V <sub>GS</sub> = 10 V	9.2	4.9		
40	0.023 at V <sub>GS</sub> = 4.5 V	8.6	4.9		

#### FEATURES

- Halogen-free According to IEC 61249-2-21
  Definition
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>q</sub> and UIS Tested
- Compliant to RoHS Directive 2002/95/EC

#### APPLICATIONS

- CCFL Inverter
- DC/DC Converter
- HDD



SO-8  $S_1$  $D_1$ 8 1 G₁  $D_1$ 7 2  $S_2$  $D_2$ 6 3  $G_2$ 5  $D_2$ 4 Top View

Ordering Information: Si4288DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

N-Channel MOSFET

N-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_A =$	25 °C, unless othe	rwise noted)			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V <sub>DS</sub>	40	v		
Gate-Source Voltage	V <sub>GS</sub>	± 20	- V		
	T <sub>C</sub> = 25 °C		9.2		
Continuous Drain Current (T <sub>1</sub> = 150 °C)	T <sub>C</sub> = 70 °C	I <sub>D</sub>	7.4	1	
Continuous Drain Current (1j = 150°C)	T <sub>A</sub> = 25 °C	D	7.4 <sup>b, c</sup>	1	
	T <sub>A</sub> = 70 °C		5.9 <sup>b, c</sup>	1	
Pulsed Drain Current (10 µs Pulse Width)	I <sub>DM</sub>	50			
Source-Drain Current Diode Current	T <sub>C</sub> = 25 °C	I <sub>S</sub>	2.6	A	
Source-Drain Current Diode Current	T <sub>A</sub> = 25 °C	'S	1.6 <sup>b, c</sup>	1	
Pulsed Source-Drain Current	I <sub>SM</sub>	50			
Single Pulse Avalanche Current		I <sub>AS</sub>	10		
Single Pulse Avalanche Energy	L = 0.1 mH	E <sub>AS</sub>	5		
	T <sub>C</sub> = 25 °C		3.1		
Maximum Rowar Dissipation	T <sub>C</sub> = 70 °C	PD	2	w	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	' D	2 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		1.28 <sup>b, c</sup>	1	
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stq</sub>	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Тур.	Max.	Unit		
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 10 s	R <sub>thJA</sub>	49	62.5	°C/W		
Maximum Junction-to-Foot (Drain)	Steady-State	R <sub>thJF</sub>	30	40	0/11		

Notes:

a. Based on T\_C = 25 °C.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s. d. Maximum under steady state conditions is 120  $^{\circ}\text{C/W}.$ 

## Si4288DY

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Parameter	Symbol	Test Conditions	Min.	Typ. <sup>a</sup>	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	40			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_J$ I <sub>D</sub> = 250 µA			49		m\//ºC	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	η <sub>D</sub> = 250 μΑ		- 5.2		mV/°C	
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.2		2.5	V	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			100	nA	
Zara Cata Valtaga Drain Current	I <sub>DSS</sub>	$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	1		1		
Zero Gate Voltage Drain Current		$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$			10	μΑ	
On-State Drain Current <sup>b</sup>	I <sub>D(on)</sub>	V <sub>DS</sub> = 5 V, V <sub>GS</sub> = 10 V	20			Α	
	Б	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$		0.0165	0.0200	Ω	
Drain-Source On-State Resistance <sup>b</sup>	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 7 \text{ A}$		0.019	0.023		
Forward Transconductance <sup>b</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 10 A		35		S	
Dynamic <sup>a</sup>	•	· · · · · · · · · · · · · · · · · · ·		•	•		
Input Capacitance	C <sub>iss</sub>			580		pF	
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ I}_{D} = 1 \text{ MHz}$		100			
Reverse Transfer Capacitance	C <sub>rss</sub>			42			
-	Qg	$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$		10	15	nC	
Total Gate Charge				4.9	7.4		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 10 \text{ A}$		1.5			
Gate-Drain Charge	Q <sub>gd</sub>			1.5			
Gate Resistance	Rg	f = 1 MHz	0.6	2.7	5.4	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			7	14		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 20 V, $R_L$ = 2 $\Omega$		9	18		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		16	32		
Fall Time	t <sub>f</sub>			8	16		
Turn-On Delay Time	t <sub>d(on)</sub>			12	24	ns	
Rise Time	tr	$V_{DD}$ = 20 V, $R_L$ = 2 $\Omega$		10	20	1	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		13	26		
Fall Time	t <sub>f</sub>			8	16		
Drain-Source Body Diode Characterist	ics			1			
Continuous Source-Drain Diode Current	ا <sub>S</sub>	T <sub>C</sub> = 25 °C			2.6		
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				50	A	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 3 A		0.77	1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			15	30	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			7.5	15	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = 5 \text{ A}, \text{ dl/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^\circ\text{C}$		9			
Reverse Recovery Rise Time	t <sub>b</sub>	۱ ۲		6		ns	

Notes:

a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

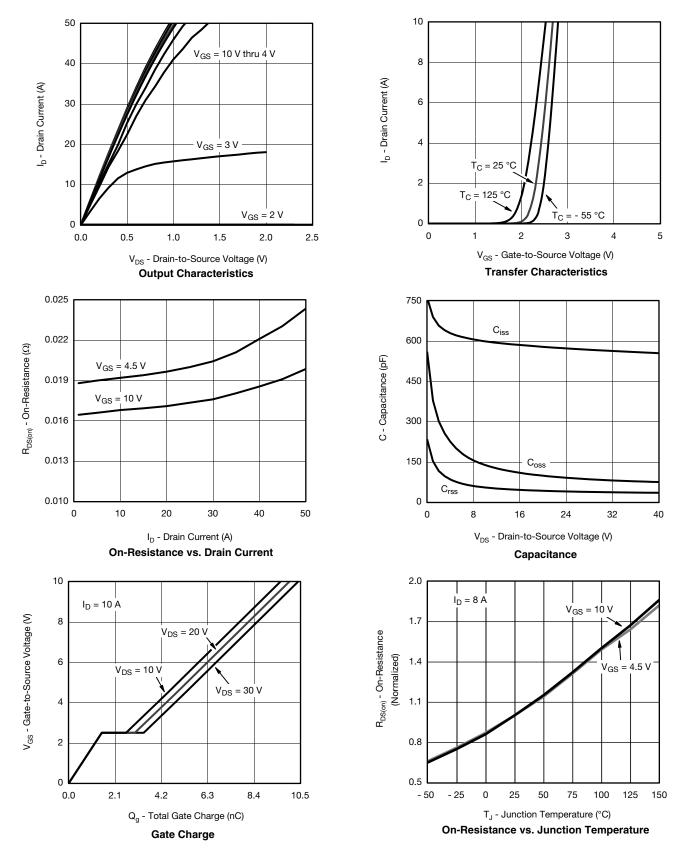
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



# Si4288DY

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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

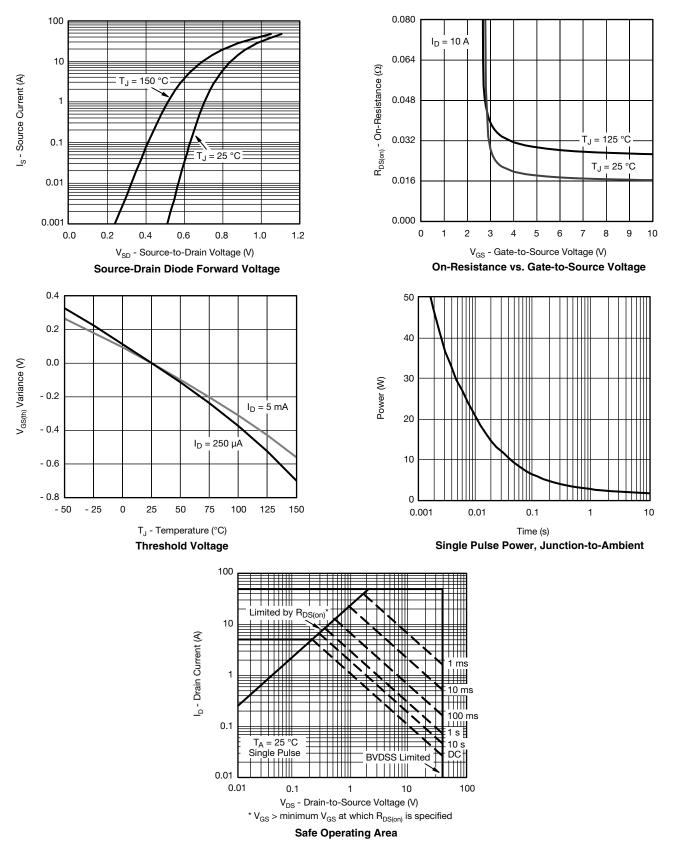


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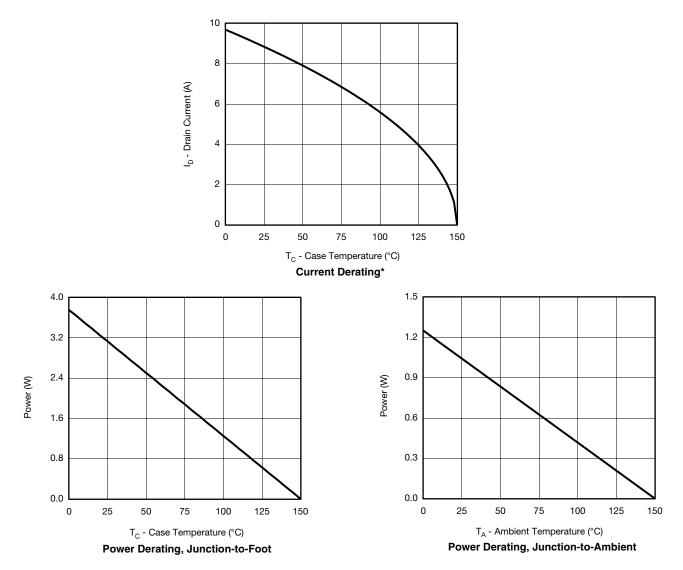
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





Si4288DY Vishay Siliconix

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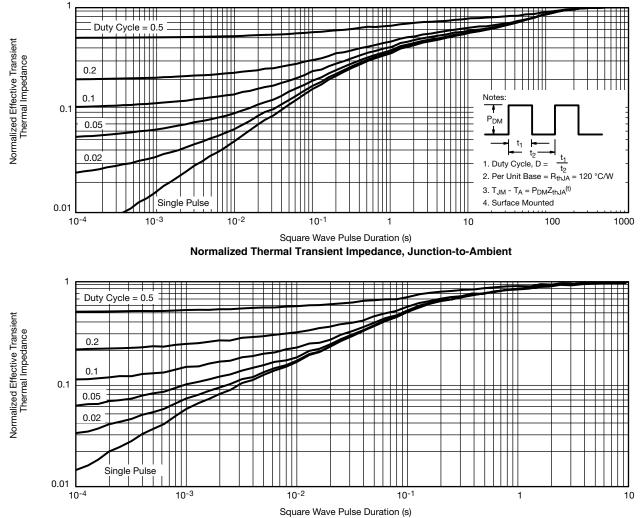


\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

### Vishay Siliconix



#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg267078">www.vishay.com/ppg267078</a>.



## Package Information

Vishay Siliconix

# SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INCHES		
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27 BSC		0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					

## **Application Note 826**

Vishay Siliconix



**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)

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